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# N- and P-Channel 20 V (D-S) MOSFET

#### **DESCRIPTION**

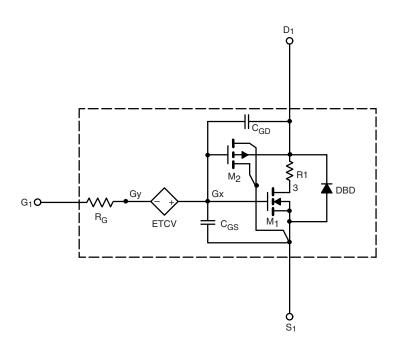
The attached SPICE model describes the typical electrical characteristics of the n- and p-channel vertical DMOS. The subcircuit model is extracted and optimized over the -  $55\,^{\circ}$ C to +  $125\,^{\circ}$ C temperature ranges under the pulsed 0 V to 5 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched  $C_{\rm gd}$  model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

### **CHARACTERISTICS**

- N and P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- · Apply for both Linear and Switching Application
- Accurate over the 55 °C to + 125 °C Temperature Range
- Model the Gate Charge

# SUBCIRCUIT MODEL SCHEMATIC N-CHANNEL



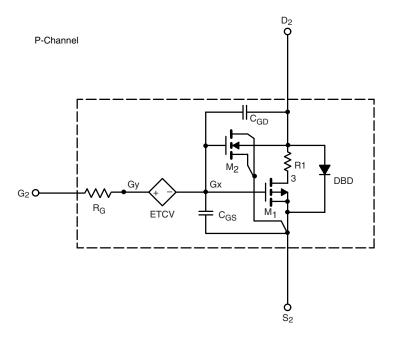
#### Note

• This document is intended as a SPICE modeling guideline and does not constitute a commercial product datasheet. Designers should refer to the appropriate datasheet of the same number for guaranteed specification limits.

# **SPICE Device Model Si5513CDC**

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# SUBCIRCUIT MODEL SCHEMATIC P-CHANNEL



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# **SPICE Device Model Si5513CDC**

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PARAMETER	SYMBOL	TEST CONDITIONS		SIMULATED DATA	MEASURED DATA	UNIT
Static						
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	N-Ch	1	-	V
		$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	P-Ch	1	-	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 4.4 \text{ A}$	N-Ch	0.044	0.045	Ω
		$V_{GS} = -4.5 \text{ V}, I_D = -2.4 \text{ A}$	P-Ch	0.12	0.12	
		$V_{GS} = 2.5 \text{ V}, I_D = 3.6 \text{ A}$	N-Ch	0.067	0.065	
		$V_{GS} = -2.5 \text{ V}, I_D = -1.9 \text{ A}$	P-Ch	0.200	0.204	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 4.4 \text{ A}$	N-Ch	10	12	S
		$V_{DS} = -10 \text{ V}, I_D = -2.4 \text{ A}$	P-Ch	6	5	
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_S = 3.5 \text{ A}, V_{GS} = 0 \text{ V}$	N-Ch	0.83	0.80	V
		I <sub>S</sub> = - 1.9 A, V <sub>GS</sub> = 0 V	P-Ch	0.81	- 0.80	
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>		N-Ch	278	285	
		N-Channel	P-Ch	250	252	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ N-Ch	62	65	рF	
		P-Channel	P-Ch	62	62	pr
Reverse Transfer Capacitance	C <sub>rss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	N-Ch	29	30	
			P-Ch	44	25	
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 4.4 \text{ A}$	N-Ch	2.4	2.8	
		$V_{DS} = -10 \text{ V}, V_{GS} = -5 \text{ V}, I_D = -2.4 \text{ A}$	P-Ch	3.1	3.9	
			N-Ch	2.2	2.6	
		N-Channel	11 0114111101	3.6	nC	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 4.4 \text{ A}$	N-Ch	0.7	0.7	- nc
		P-Channel	P-Ch	0.6	0.6	
Gate-Drain Charge	Q <sub>gd</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -2.4 \text{ A}$	N-Ch	0.5	0.5	
			P-Ch	1.2	1.2	

## Notes

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

b. Guaranteed by design, not subject to production testing.

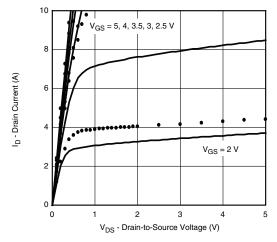


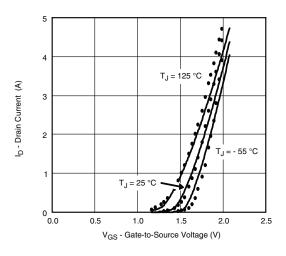
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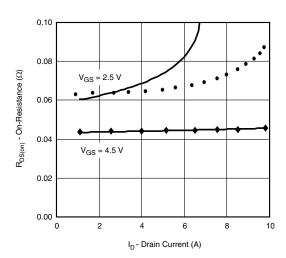
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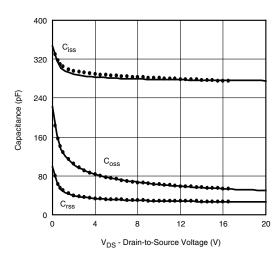
## COMPARISON OF MODEL WITH MEASURED DATA $T_J = 25~{}^{\circ}\text{C}$ , unless otherwise noted

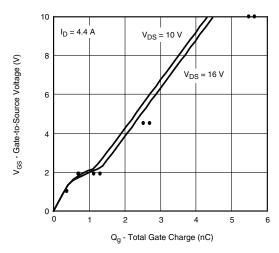
### **N-Channel MOSFET**

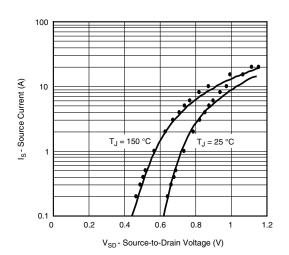












#### Note

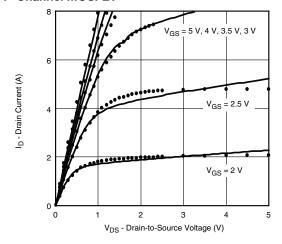
Dots and squares represent measured data.

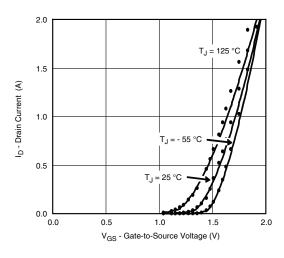
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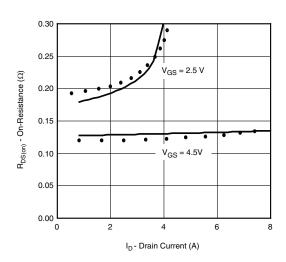
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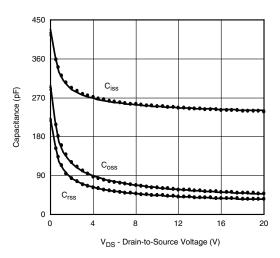
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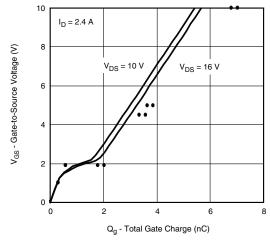
#### **P-Channel MOSFET**

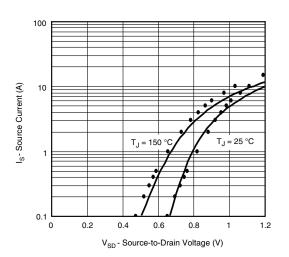












#### Note

• Dots and squares represent measured data.



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